

a-Si:H as active material for the detection of different radiations observed during the evolution of Solar Energetic Particle events

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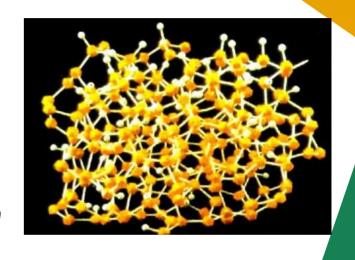
a-Si:H



Why a-Si:H as material?



- → it is intrinsically radiation resistant;
- → it has a charge collection efficiency half the c-Si;
- \rightarrow it can be deposited in thin layers (~ 1-100 μ m);
- → it can be deposited with any pattern on the substrate (lithography)
- → it can be deposited on different substrates, even flexible ones like mylar and kapton;
- → it is possible a low weight device with a wide area.





Possible applications in space of a-Si:H detectors: the scientific case



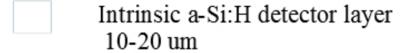
- Solar energetic particle (SEP) continuous, multi-spacecraft observations allow us to study the role of interplanetary propagation and transport effects.
- Critical energy differential flux measurements from tens of MeV up to not less than 400 MeV for protons are proposed for reliable measurement parameterization above these energies and for flux normalization: goal medium-intense events (>10⁷ protons cm⁻² > 30 MeV).



How a device will look like?



p-i-n structure: signal generated in intrinsic layer





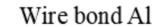
70 um kapton

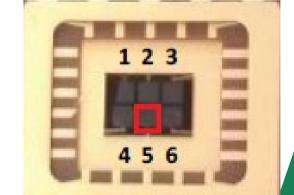
p-doped a-Si:H junction layer

Metal layer (Cr + Al)

n-doped a-Si:H junction

detector pad or bias Pad in Copper





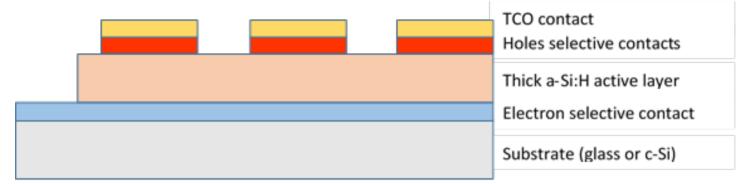
6 diodes: $1 \times 1 \text{ mm} \times 10 \mu \text{m}$



a-Si:H contact types



Charge Selective Contacts (CSC): two thin layers of metal oxides sandwiching the sensitive a-Si:H film.



Our first prototypes:

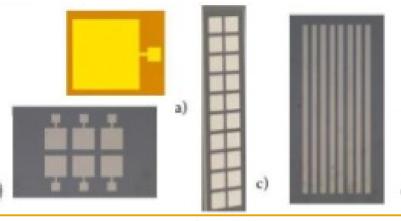
- → electron selective contacts: ZnO:Al or TiO₂
- → hole selective contacts: MoOx

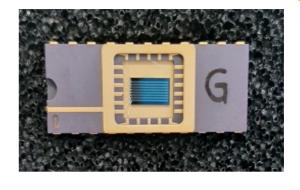
Selective contact layer thickness < 30 nm; intrinsic layer (1-10 μ m)



a-Si:H protoypes







Packaging: socket



p-i-n devices over Kapton (25 μ m) 2x2 mm² and 5x5 mm².

Possibility to create devices < 100 μ m thickness on flexible support



Packaging: using kapton long tails

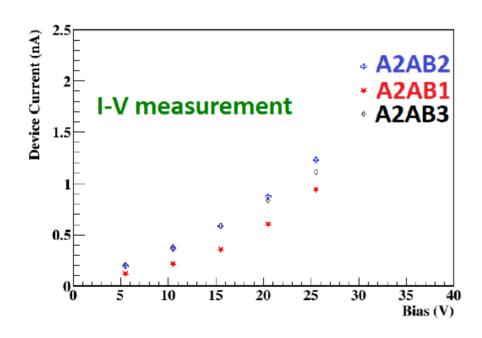


Characterization of a-Si:H device



I-V curve for devices belonging to same batch is similar, on average within 5%

Maximum difference < 20 %

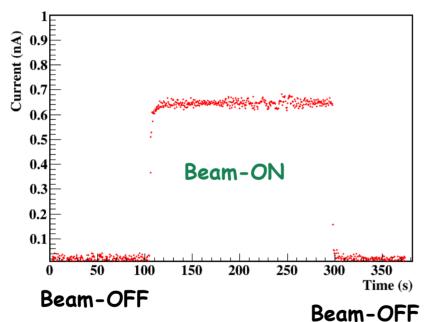




Noise of a-Si:H device

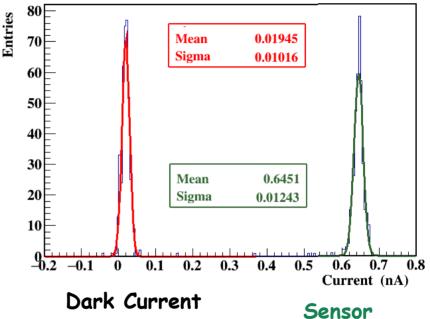


Response to X-ray beam: 30 kV, 100 μ A, 4x4 mm², 8.2 μ m thick, 0 V bias



Noise Beam-OFF ~ 10 pA





Noise Beam-ON ~ 12 pA

Response

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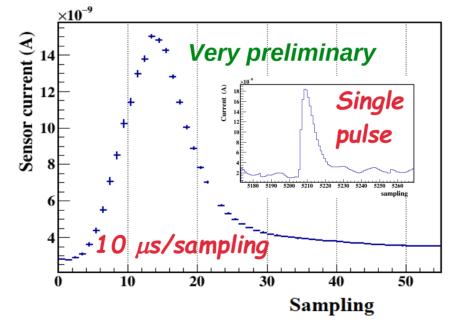


Time response of a-Si:H device



X-ray from clinic beams: many "pulses", 3 μ s long made of many subpulses and spaced by 3 ms. With our front-end we could detect each pulse as a convolution of pulse shape and front-end time

resolution.



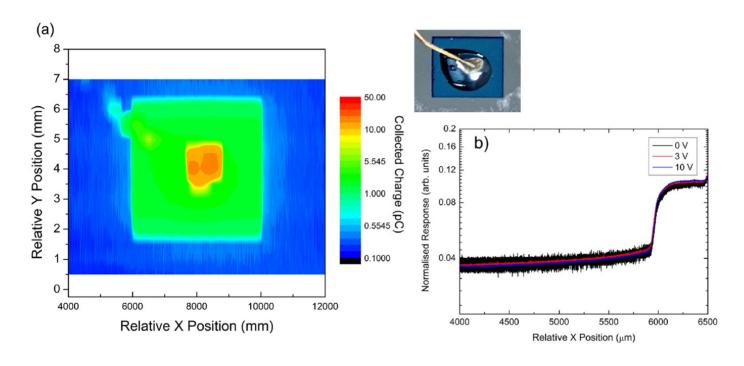
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Sensitive Volume of a-Si:H device



X-Ray Beam Induced Voltage (XBIC) technique:



M. Large et al: "Hydrogenated amorphous silicon high flux x-ray detectors for synchrotron microbeam radiation therapy", Phys. Med. and Biol. doi: 10.1088/1361-6560/acdb43

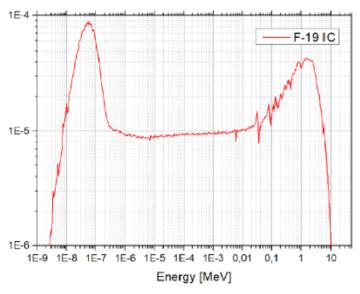


Lethargy spectra [relative units]

Radiation Resistance of a-Si:H device

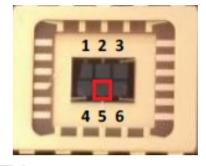


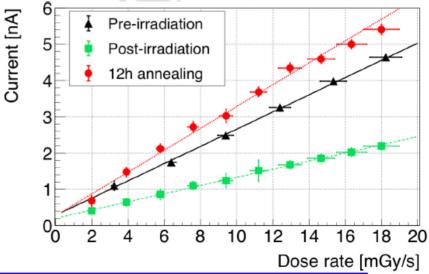
Damage using neutrons (JSI - Ljubljana)



 $1 \times 10^{16} n_{eq(1MeV)}/cm^2$

0.5x0.5 mm 2 10 μ m thick 60 V bias





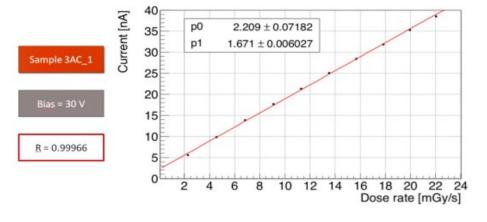
M. Menichelli et al: "Neutron irradiation of Hydrogenated Amorphous Silicon p-i-n diodes and charge selective contacts detectors", Nucl. Inst. Meth. A (2023) doi: 10.1016/j.nima.2023.168308



Sensitivity of a-Si:H device

a-Si:H

X-ray tests in laboratory (< 30 kV, peak energy ~ 10 keV)



Excellent linearity, deviation < 5%

Sensitivity 1-10 nC/cGy

Detector type and bias	Sensitivity (nC/cGy)
CSC at 30V bias	11.1 ± 0.3
CSC at 0V bias	0.86 ± 0.03
P-i-n diode at 60V	2.39 ± 0.09

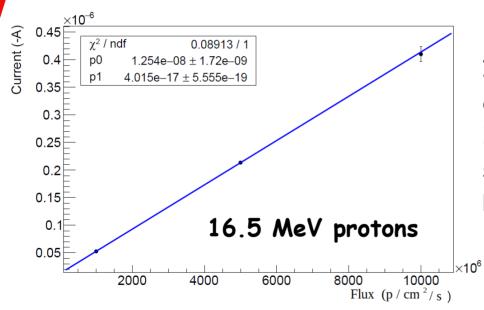
M. Menichelli et al: "Neutron irradiation of Hydrogenated Amorphous Silicon p-i-n diodes and charge selective contacts detectors", Nucl. Inst. Meth. A (2023) doi: 10.1016/j.nima.2023.168308



Sensitivity of a-Si:H device



Protons from several sources: 3 MeV (CEDAD), 16.5 MeV (Berne Cyclotron), 228 MeV, 70 MeV (Trento Hadrontherapy)



In all measurements, done with different sensors, a linear response has been found with sensitivity at the same order of magnitude level predicted by SRIM simulations.



In order to evaluate the detection capability of a a-Si:H device to past SEP events, we define the following device:

 $4x4 \text{ mm}^2$ area, $8.2 \mu \text{m}$ thickness, sensitivity 2 nC/cGy.

We define a 5x5 matrix of such devices (20x20 mm² total area) connected in parallel.

The total noise of such a device is estimated at 25 pA.

The detection limit is a S/N > 5, i.e. signal > 125 pA.





Minimum detectable flux for several photon energies up to 40 keV

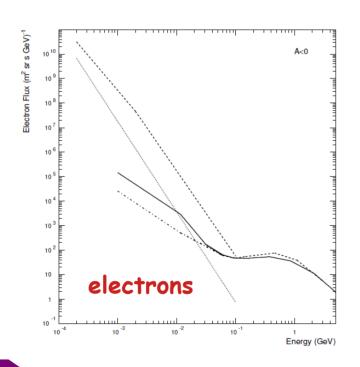
Table 5 Detection limits at 5σ for monochromatic photon fluxes.

Photon Energy [keV]	Minimum detectable flux $[\gamma/(cm^2 s)]$
3.0	$2.4 \cdot 10^3$
5.0	$3.8 \cdot 10^{3}$
10.0	$10.2 \cdot 10^3$
15.0	$20.2 \cdot 10^3$
20.0	$33.0 \cdot 10^3$
25.0	$47.8 \cdot 10^3$
30.0	$79.8 \cdot 10^3$
35.0	$150.0 \cdot 10^3$
40.0	$237.0 \cdot 10^3$





To evaluate the limits for electron flux detection we took the spectra of November 7, 1973 SEP.



Integrating the flux from 50 keV up to 1 GeV, taking into account the deposition of energy with FLUKA simulation, we obtain a signal of 45 pA, i.e. $5/N \sim 2$.

Barely over the noise level. Work in progress





For protons we found the minimum flux that will produce a S/N > 5 for monochromatic flux.

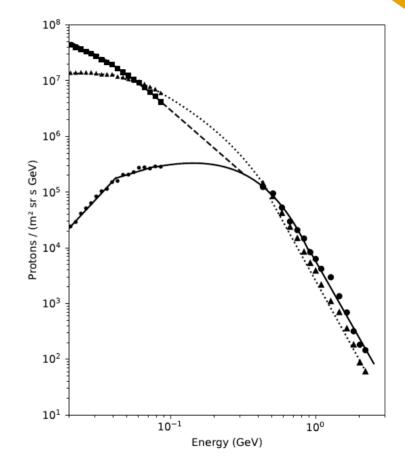
Detection limits at 5σ for monochromatic proton fluxes.

	Proton Energy [MeV]	$S/N = 5 \text{ Flux } [p (cm^2 s)^{-1}]$
	5.0	$0.4 \cdot 10^3$
	10.0	$0.5 \cdot 10^3$
At low energy the number	20.0	$1.0 \cdot 10^3$
of protons / sec / cm ²	50.0	$1.5 \cdot 10^3$
is of the order of few	70.0	$3.0 \cdot 10^{3}$
	100.0	$3.5 \cdot 10^3$
hundreds.	200.0	$5.0 \cdot 10^3$
	400.0	$10.0 \cdot 10^3$





Using the measured proton spectra of October 28, 2021 SEP we obtain a signal of 85 pA, i.e. S/N = 3.8







Improvements:

- → noise reduction below 1 pA. The readout is the current limit and we will improve it. We have just submitted a new ASIC chip in 28 nm node (Cleopatra).
- → improved sensitivity. Better contact type and/or deposition procedures; ~ 5 improvement factor
- \rightarrow increase sensor thickness; up to 30 $\mu \rm m$ is feasable. ~ 3.5 improvement factor

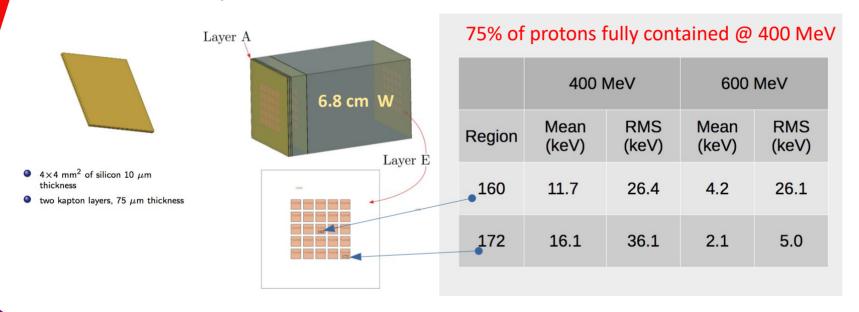


Work in Progress:

→ Simulations with Fluka of full device



a-Si:H not present as MC material \rightarrow we have to parametrize it and validate wrt experimental measurements:



Final goal: definition of optimized full device



References:



→ M. Menichelli et al: "Fabrication of a hydrogenated amorphous silicon detector in 3-d geometry and preliminary test on planar prototypes", Instruments (2021) doi: 10.3390/instruments5040032

- → M. Menichelli et al: "Testing of planar hydrogenated amorphous silicon sensors with charge selective contacts for the construction of 3D-detectors" Journ. of Instr. (2022) 17 C03033 doi: 10.1088/1748-0221/17/03/C03033
- → M. Menichelli, L. Servoli, N. Wyrsch: "Status and perspectives of hydrogenated amorphous silicon detectors for MIP detection and beam flux measurements" Frontiers in Physics (2022) 10, 943306 doi: 10.3389/fphy.2022.943306
- → F. Peverini et al: "High-Resolution Photoemission Study of Neutron-Induced Defects in Amorphous Hydrogenated Silicon Devices" Nanomaterials (2022) 12, 3466 doi: 10.3390/nano12193466
- → M. Large et al: "Hydrogenated amorphous silicon high flux x-ray detectors for synchrotron microbeam radiation therapy", Phys. Med. and Biol. doi: 10.1088/1361-6560/acdb43









